MOSFETs Silicon P-Channel MOS

# SSM3J35CTC

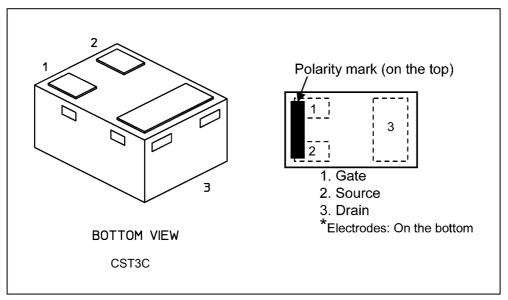
### 1. Applications

Analog Switches

### 2. Features

- (1) 1.2 V drive
- (2) Low drain-source on-resistance
  - $\begin{array}{l} : \mathrm{R}_{\mathrm{DS(ON)}} = 3.2 \ \Omega \ (\mathrm{typ.}) \ (@\mathrm{V}_{\mathrm{GS}} = -1.2 \ \mathrm{V}) \\ \mathrm{R}_{\mathrm{DS(ON)}} = 2.3 \ \Omega \ (\mathrm{typ.}) \ (@\mathrm{V}_{\mathrm{GS}} = -1.5 \ \mathrm{V}) \\ \mathrm{R}_{\mathrm{DS(ON)}} = 2.0 \ \Omega \ (\mathrm{typ.}) \ (@\mathrm{V}_{\mathrm{GS}} = -1.8 \ \mathrm{V}) \\ \mathrm{R}_{\mathrm{DS(ON)}} = 1.5 \ \Omega \ (\mathrm{typ.}) \ (@\mathrm{V}_{\mathrm{GS}} = -2.5 \ \mathrm{V}) \\ \mathrm{R}_{\mathrm{DS(ON)}} = 1.1 \ \Omega \ (\mathrm{typ.}) \ (@\mathrm{V}_{\mathrm{GS}} = -4.5 \ \mathrm{V}) \end{array}$

### 3. Packaging and Pin Assignment



### 4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	-20	V
Gate-source voltage		V <sub>GSS</sub>	±10	
Drain current (DC)	(Note 1)	I <sub>D</sub>	-250	mA
Drain current (pulsed)	(Note 1)	I <sub>DP</sub>	-600	
Power dissipation	(Note 2)	PD	500	mW
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature		T <sub>stg</sub>	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ensure that the channel temperature does not exceed 150 °C.

- Note 2: Device mounted on a 25.4 mm × 25.4 mm × 1.6 mm FR4 glass epoxy board (Cu pad: 645 mm<sup>2</sup>)
- Note: This transistor is sensitive to electrostatic discharge and should be handled with care.
- Note: The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.
- Note: The channel-to-ambient thermal resistance, R<sub>th(ch-a)</sub>, and the drain power dissipation, P<sub>D</sub>, vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.

### 5. Electrostatic Discharge Test (Ta=25°C)

Apply voltage	Failure	Test conditions
±2000 V	0/10 pcs	C = 100 pF, R = 1.5 kΩ (JEITA ED-4701)

Note: Conducted Electrostatic Discharge Test based on JEITA ED-4701 standard, and confirmed above result.

### 6. Electrical Characteristics

### 6.1. Static Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ±10 V	_	_	±1	μA
Drain cut-off current		I <sub>DSS</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V	_	_	-1	
Drain-source breakdown voltage		V <sub>(BR)DSS</sub>	I <sub>D</sub> = -1 mA, V <sub>GS</sub> = 0 V	-20	_	_	V
Drain-source breakdown voltage	(Note 1)	V <sub>(BR)DSX</sub>	I <sub>D</sub> = -1 mA, V <sub>GS</sub> = 10 V	-10	_	_	
Gate threshold voltage	(Note 2)	V <sub>th</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -100 μA	-0.3	_	-1	
Drain-source on-resistance	(Note 3)	R <sub>DS(ON)</sub>	I <sub>D</sub> = -10 mA, V <sub>GS</sub> = -1.2 V	_	3.2	20	Ω
			I <sub>D</sub> = -20 mA, V <sub>GS</sub> = -1.5 V	_	2.3	4.0	
			I <sub>D</sub> = -50 mA, V <sub>GS</sub> = -1.8 V	_	2.0	2.9	
			I <sub>D</sub> = -150 mA, V <sub>GS</sub> = -2.5 V	_	1.5	2.1	
			I <sub>D</sub> = -150 mA, V <sub>GS</sub> = -4.5 V		1.1	1.4	
Forward transfer admittance	(Note 3)	Y <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -100 mA	_	430	_	mS

Note 1: If a reverse bias is applied between gate and source, this device enters V<sub>(BR)DSX</sub> mode. Note that the drainsource breakdown voltage is lowered in this mode.

Note 3: Pulse measurement.

### 6.2. Dynamic Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V,	_	21	42	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		2	—	
Output capacitance	C <sub>oss</sub>			6	_	
Switching time (rise time)	tr	V <sub>DD</sub> = -10 V, I <sub>D</sub> = -50 mA,		42	—	ns
Switching time (turn-on delay time)	t <sub>d(on)</sub>	$V_{GS}$ = 0 to -4.5 V, R <sub>G</sub> = 10 Ω Duty ≤ 1 %, V <sub>IN</sub> : t <sub>r</sub> , t <sub>f</sub> < 5 ns,		17	_	
Switching time (fall time)	t <sub>f</sub>	Common source, See Chapter 6.3.		145	_	
Switching time (turn-off delay time)	t <sub>d(off)</sub>			420	_	

### 6.3. Switching Time Test Circuit

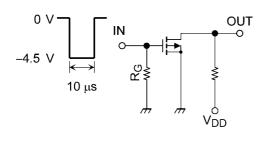


Fig. 6.3.1 Switching Time Test Circuit

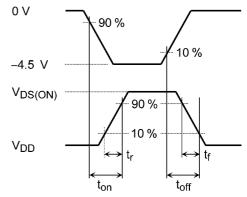


Fig. 6.3.2 Input Waveform/Output Waveform

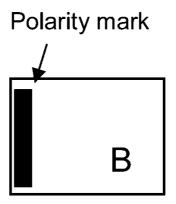
Note 2: Let  $V_{th}$  be the voltage applied between gate and source that causes the drain current (I<sub>D</sub>) to below (-100  $\mu$ A for this device). Then, for normal switching operation,  $V_{GS(ON)}$  must be higher than  $V_{th}$ , and  $V_{GS(OFF)}$  must be lower than  $V_{th}$ . This relationship can be expressed as:  $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$ . Take this into consideration when using the device.

### 6.4. Source-Drain Characteristics (Unless otherwise specified, $T_a = 25$ °C)

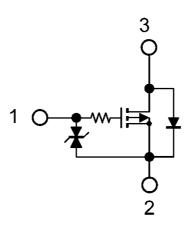
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage	(Note 1)	$V_{\text{DSF}}$	$I_{D}$ = 100 mA, $V_{GS}$ = 0 V	—	0.83	1.2	V

Note 1: Pulse measurement.

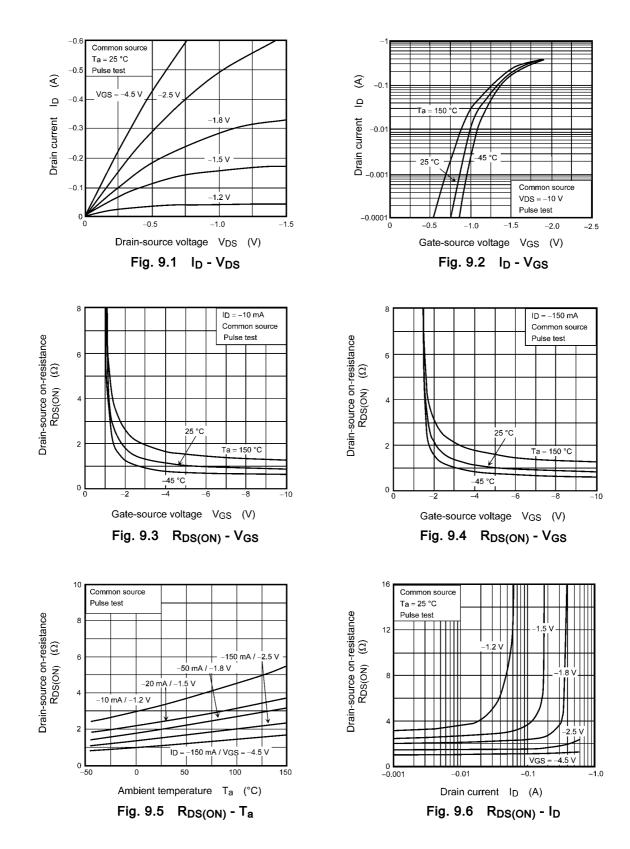
### 7. Marking



### 8. Equivalent Circuit



9. Characteristics Curves (Note)



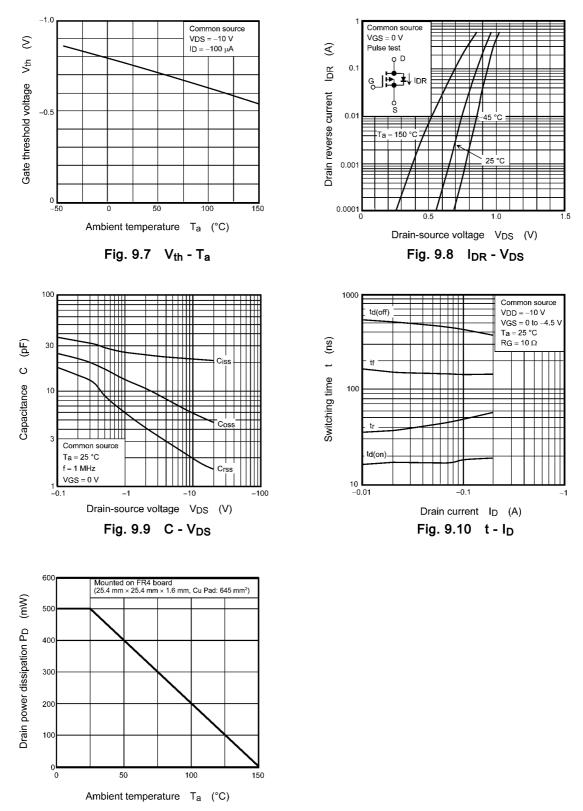


Fig. 9.11 P<sub>D</sub> - T<sub>a</sub>

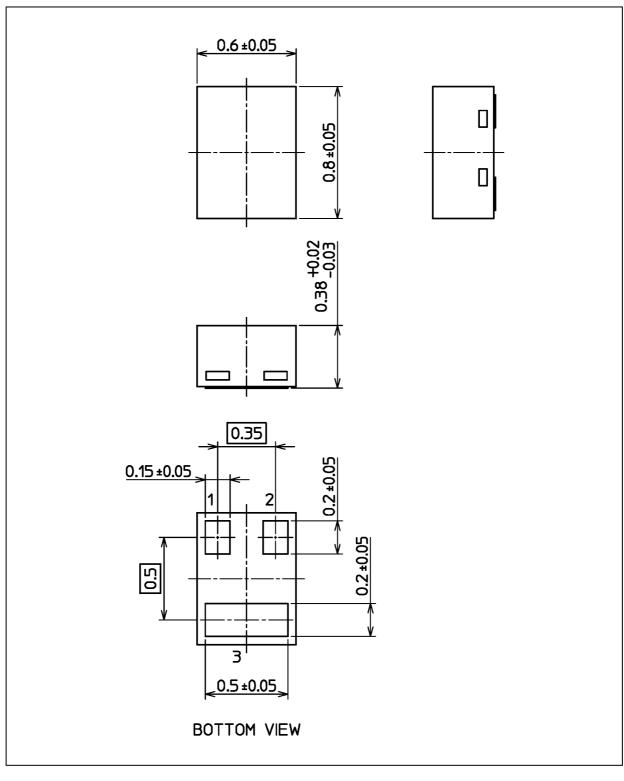
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



### SSM3J35CTC

### **Package Dimensions**

Unit: mm



Weight: 0.55 mg (typ.)

Package Name(s)

Nickname: CST3C

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